

PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.		IPD/15/9333
1.3 Title of PCI		Orientation of PowerFLAT™ 3.3x3.3 Package in carrier tape.
1.4 Product Category		Power MOSFET
1.5 Issue date		2015-07-21

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Mario Antonio ALEO
2.1.2 Marketing Manager	Anna MOTTESE
2.1.3 Quality Manager	Vincenzo CAVALLARO

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	Any indirect material modifications for shipping products in dimensions, material, composition, orientation...	FUJITSU (China)

4. Description of change

	Old	New
4.1 Description	PowerFLAT™ 3.3x3.3 from NFME (China) is oriented with notch on the upper left side.	PowerFLAT™ 3.3x3.3 from NFME (China) is oriented with notch on the upper right side.
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no impact	

5. Reason / motivation for change

5.1 Motivation	To improve Customers service
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	by data code
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7. Timing / schedule

7.1 Date of qualification results	2015-07-15
7.2 Intended start of delivery	2015-08-17
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation

8.1 Description	Comparison.pdf	
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date

9. Attachments (additional documentations)

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STL11N3LLH6	
	STL4N10F7	
	STL6P3LLH6	
	STL7N10F7	
	STL8N10F7	
	STL9P2UH7	

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